

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT2777244

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>KYOKO TAKEDA</td><td>03/11/2014</td></tr><tr><td>SATOSHI SEO</td><td>03/12/2014</td></tr><tr><td>HIROMI SEO</td><td>03/10/2014</td></tr><tr><td>TATSUYOSHI TAKAHASHI</td><td>03/10/2014</td></tr></tbody></table>	Name	Execution Date	KYOKO TAKEDA	03/11/2014	SATOSHI SEO	03/12/2014	HIROMI SEO	03/10/2014	TATSUYOSHI TAKAHASHI	03/10/2014	
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TATSUYOSHI TAKAHASHI	03/10/2014										
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Postal Code:	243-0036										
PROPERTY NUMBERS Total: 1											
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>14220398</td></tr></tbody></table>	Property Type	Number	Application Number:	14220398							
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Application Number:	14220398										
CORRESPONDENCE DATA											
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NAME OF SUBMITTER:	MARK J. MURPHY										
SIGNATURE:	/Mark J. Murphy/										
DATE SIGNED:	03/20/2014										
Total Attachments: 1 source=AssignmentSEL1150#page1.tif											

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PATENT
REEL: 032484 FRAME: 0538

ASSIGNMENT

Identity Of The Patent Application. I am the inventor (or one joint inventor) of a patent application that I am assigning. The patent application I am assigning is entitled ORGANIC COMPOUND, LIGHT-EMITTING ELEMENT, LIGHT-EMITTING DEVICE, ELECTRONIC DEVICE, AND LIGHTING DEVICE which I executed herewith. If the patent application has already been filed, it received serial number _____ and bears a filing date of _____.

The Assignee and The Assignment. I assign my patent rights to Semiconductor Energy Laboratory Co., Ltd. a corporation organized according to the laws of Japan, having a place of business at 398, Hase, Atsugi-shi, Kanagawa-ken, 243-0036 Japan (hereinafter "the Assignee"). The rights I assign are my entire right, title and interest in the invention or improvements disclosed in the patent application and any and all other applications for United States Letters Patent which I may file, either solely or jointly with others, on the invention or improvements, including all continuations, divisionals, and continuations-in-part, and in any and all United States Letters Patent which may be obtained on any of said applications, and in any reissue or extension thereof. I also assign to the Assignee all priority rights under the International Convention. I agree to execute, at the request of the Assignee, all documents in connection with any application for United States letters patent therefor.

Payment Received. I am making this assignment in consideration of One Dollar and other good and valuable consideration. I acknowledge the receipt and sufficiency of the consideration.

Authorizations. I request the U.S. Commissioner of Patents and Trademarks to issue the Letters Patent to the Assignee. I authorize the attorney(s) of record in the application to insert in this assignment document the date and serial number of the application.

Further Acts. I agree, upon the request and at the expense of the Assignee, to execute any divisional, continuation or substitute application for the invention or improvements, and any oath, declaration or affidavit relating thereto, and any application for the reissue or extension of any Letters Patent that may be granted upon the application. I agree to perform, upon request, any affirmative acts to obtain said Letters Patent of the United States and to vest in the Assignee all rights therein, so that the Letters Patent will be held and enjoyed by the Assignee, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me if this assignment had not been made.

Interference. In the event that any application or Letters Patent that I now assign becomes involved in interference, I agree to cooperate to the best of my ability in the matters of preparing and executing the preliminary statement and giving and producing evidence in support thereof.

Kyoko TAKEDA	03/11/2014
Name: Kyoko TAKEDA	Date
Satoshi Seo	03/12/2014
Name: Satoshi SEO	Date
Hiromi Seo	03/10/2014
Name: Hiromi SEO	Date
Tatsuyoshi Takahashi	03/10/2014
Name: Tatsuyoshi TAKAHASHI	Date